

SPECIFICATION
RESIN MOLDING APPARATUS
BACKGROUND OF THE INVENTION

1. Field of the Invention

5 The present invention relates to a resin molding apparatus for a transfer molding.

2. Disclosure of the Prior Art

In the past, a transfer molding method has been performed to seal semiconductor elements or the like with a thermosetting resin such as an epoxy resin, phenol resin or an unsaturated polyester resin.

As shown in FIG. 14, a single-plunger type molding apparatus for a transfer molding comprises an upper mold **20D**, a lower mold **10D**, a heater (not shown) for heating the upper and lower molds, a mold cavity **2D** formed between the upper and lower molds. The lower mold **10D** has a lower cylinder **11D** and a plunger **30D** slidable along an inner wall of the lower cylinder. On the other hand, the upper mold **20D** has a concave **21D** for a cull, which is formed at a position facing to the lower cylinder **11D**. When the upper mold **20D** is clamped to the lower mold **10D**, a side end of the concave **21D** connects with a runner **12D** formed in a top surface of the lower mold. As a result, the mold cavity **2D** is connected with an inner space **13D** of the lower cylinder **11D** through the runner **12D** and the concave **21D** to obtain a resin channel.

As explained below, a transfer molding method is performed to obtain a molded article by the use of this molding apparatus. For preventing the occurrence of voids in the molded article, a powder-like

resin material **1D** such as a thermosetting resin or the like is preformed to a tablet shape to remove an air included in the powder-like resin material. After the pressed resin material having the tablet shape is charged into the lower cylinder **11D**, it is pressed by an upward
5 movement of the plunger **30D** while being heated by the heater. The pressed and heated resin material is supplied to the mold cavity **2D** through the runner **12D**.

By this transfer molding method, it is possible to prevent the occurrence of voids in the molded article. However, there are problems
10 of increasing production steps as a whole, and causing a cost-up due to the introduction of a pretreatment apparatus of preforming the powder-like resin material to the tablet shape. Therefore, it is desired to perform the transfer molding method by using the powder-like resin material without the pretreatment. However, it is difficult to prevent
15 the occurrence of voids by using the molding apparatus of the prior art without the pretreatment.

SUMMARY OF THE INVENTION

For improving the above problems, the present invention provides a resin molding apparatus for producing a molded article from a
20 powder-like resin material while preventing the occurrence of void defectives without a pretreatment of preforming the resin material into a tablet shape. That is, the molding apparatus of the present invention comprises an upper mold, a lower mold having a cylinder, a heater for heating the upper and lower molds, a first plunger slidable along an
25 inner wall of the cylinder, a mold cavity formed in a configuration of the molded article between the upper and lower molds, a runner

connecting between the mold cavity and a space into which the resin material is charged, i.e., a space surrounded with the inner wall of the cylinder, the first plunger, and the upper mold disposed at the opposite side of the first plunger, and a gate member movable between a close position and an open position of the runner. At the close position, the charged resin material is pressed by a movement of the first plunger while being indirectly heated by the heater. At the open position, the resin material in a substantially melted state is pressed and supplied to the mold cavity by a further movement of the first plunger.

It is preferred that the upper mold is formed with the following components. That is, the upper mold comprises a second cylinder having a larger diameter than the first cylinder of the lower mold, and a second plunger slidable along an inner wall of the second cylinder. The upper mold is disposed on the lower mold such that an inside of the second cylinder is joined with that of the first cylinder. The second plunger acting as the gate member makes the close position of the runner when being pressed against the lower mold. The upper mold also has a pressure loading unit and a pressure release unit. The pressure loading unit applies a load to the second plunger toward the lower mold when the resin material is pressed between the first and second plungers while the close position of the runner being kept. The pressure release unit removes the load applied to the second plunger. The second plunger makes the open position of the runner when being spaced away from the lower mold.

It is also preferred that the gate member is formed with a pin projectable into the runner.

It is further preferred that the gate member is formed with a slide block which is slidably supported in a direction of crossing the runner. The slide block has a through hole extending in a lengthwise direction of the runner. When the slide block is moved in the direction of
5 crossing the runner such that the through hole comes into a registration with the runner, the open position of the runner is obtained.

These and still other objects and advantages will become apparent from the following description of the preferred embodiments of the invention when taken in conjunction with the attached drawings.

10 BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a top view of a resin molding apparatus of the present invention;

FIG. 2 is a front view of the resin molding apparatus of the present invention;

15 FIG. 3 is a side view of the resin molding apparatus of the present invention;

FIG. 4 is a cross-sectional view of a molding unit A1 of the molding apparatus;

FIGS. 5A to 5D show a transfer molding method using the molding unit
20 A1 of the present invention;

FIGS. 6A and 6B show a removing step of a molded article;

FIG. 7 is a modification of the molding unit A1;

FIGS. 8A and 8B show an action of a slide block;

FIGS. 9A to 9D show a transfer molding method using a molding unit
25 A2 of the present invention;

FIG. 10 is a control diagram of first and second plungers;

FIGS. 11A to 11D show a transfer molding method using a molding unit **A3** of the present invention;

FIG. 12 is a front view of a unit **B** for measuring and supplying a powder-like resin material;

5 FIGS. 13A and 13B illustrate an action of a measuring section of the unit **B**; and

FIG. 14 is a resin molding apparatus of the prior art.

PREFERRED EMBODIMENTS OF THE INVENTION

As shown in FIGS. 1 to 3, a resin molding apparatus of the present invention is formed with a molding unit **A1** for performing a transfer molding step, a unit **B** for measuring a powder-like resin material and supplying the resin material to the molding unit, a unit **C** for supplying a frame member to be sealed with the resin material to the molding unit, a unit **D** for removing a molded article from the molding unit after the transfer molding step, a unit **E** for providing the frame member to the unit **C**, and a unit **F** for storing the molded article.

As shown in FIG. 4, the molding unit **A1** comprises an upper mold **20**, a lower mold **10** having a cylinder **11**, a plunger **30** slidable along an inner wall of the cylinder, and mold cavities **2** each of which is formed in a configuration of the molded article between the upper and lower molds. The upper mold **20** has a concave **21** for a cull, which is formed at a position facing to the cylinder **11**. When the upper mold **20** is clamped to the lower mold **10**, opposite side ends of the concave **21** connect with runners **12** formed on the lower mold. As a result, the mold cavities **2** are connected with an inside of the cylinder **11D** through the runners **12** and the concave **21** to define resin channels.

FIG. 4 shows one pair of the resin channels extending between the inside of the cylinder **11** and the mold cavities **2**. In this molding apparatus, the molding unit **A1** is formed with a plurality of cylinders **11** each having the pair of the resin channels.

5 The upper mold **20** has a pair of gate pins **22** projectable into the concave **21**. When tops of the gate pins **22** are pressed against a top surface of the lower mold **10**, the resin channels are closed. On the other hand, when the gate pins **22** are retracted from the concave **21**, the resin channels are opened.

10 The upper mold **20** is supported to an upper base **25** through an upper attachment board **23**. Similarly, the lower mold **10** is supported to a lower base **17** through a lower attachment board **15**. At least one of the upper base **25** and the lower base **17** can be moved up and down by a hydraulic-type or electric-type driving apparatus (not shown). In
15 FIG. 4, numerals **26** and **16** designate holes respectively formed in the upper and lower attachment boards (**23**, **15**) to arrange therein heaters (not shown) for heating the upper and lower molds. In addition, numeral **31** designates a columnar rod for moving the plunger **30** up and down. Numeral **40** designates an ejector pin used to remove the
20 molded article from the upper and lower molds. Numeral **50** designates a spring.

 Prior to a transfer molding step with the use of the molding unit **A1**, lead frames **8** to be sealed with the resin material are transferred from a magazine rack **60** to a table **62** for preheating the lead frames by
25 a supply pusher **61** of the unit **E**, as shown in FIG. 1. A positioning step of the lead frames **8** is also performed on the table **62**. After the

upper mold is separated from the lower mold, the lead frames **8** on the table **62** are supplied into the mold cavities **2**. In addition, a powder-like resin material **1** such as a thermosetting resin stored in a hopper **101** of the unit **B** is measured by a measuring section **104** of the unit **B**,
5 and then the measured resin material is supplied to a space **13** in each of the cylinders **11** of the lower mold **10**. Subsequently, as shown in FIG. 5A, the upper mold **20** is clamped to the lower mold **10**, and the resin channels are closed by the gate pins **22**. The upper and lower molds (**10**, **20**) are heated by the heaters to indirectly heat the resin
10 material **1** charged into the cylinder **11**. The plunger **30** is then moved upwardly to press the resin material **1**, as shown in FIG. 5B. During this heating and pressing step of the resin material **1**, an air in the cylinder **11** including an air left in the powder-like resin material is exhausted through a clearance between the plunger **30** and the cylinder.
15 To improve the exhaustion of the air in the cylinder **11** to the outside, a vacuum pump or the like may be preferably used.

Immediately after the resin material is heated and pressed to obtain a substantially melted state thereof, the gate pins **22** are retracted from the concave **21** to open the resin channels, as shown in FIG. 5C.
20 The plunger **30** and the cylinder **11** are produced to tightly restricted dimensional tolerances such that the air in the cylinder can be exhausted to the outside through the clearance between the plunger and the cylinder, but the melted resin material can not sink into the clearance in a short time period. When the gate pins **22** are retracted,
25 and the melted resin material is pressed by the plunger **30**, the melted resin material is injected into the mold cavities **2** through the runners

12. The plunger 30 is moved upwardly until a top of the plunger reaches a position slightly higher than the top surface of the lower mold 10, as shown in FIG. 5D, to finish the injection of the resin material 1 into the mold cavities 2. As described above, since the air in the powder-like resin material is exhausted to the outside before the resin channels are opened, it is possible to produce good molded articles with no void by the resin material injected into the mold cavities 2. In addition, the resin channels are opened when the resin material 1 is uniformly melted, therefore, it is possible to smoothly supply the melted resin material into the mold cavities.

As shown in FIGS. 6A and 6B, after the injected resin material 1 cures in the mold cavities 2, the molded articles can be removed from the mold cavities. The molded articles are chucked by the unit D, and then placed on a pick-up table 70. The molded articles on the pick up table 70 are accommodated in a magazine rack 80 of the unit F by an action of a second pusher 71.

As a modification of the unit A1, it is possible to use slide blocks 27 in place of the gate pins 22, as shown in FIG. 7. That is, each of the slide blocks 27 is slidably supported in a direction of crossing the runner 12 (resin channel), and has a through hole 28 extending in a lengthwise direction of the runner 12. As shown in FIG. 8A, when the runner 12 is closed by the slide block 27, a closed state of the resin channel is obtained. On the other hand, as shown in FIG. 8B, when the slide block 27 is moved in the direction of crossing the runner 12 such that the through hole 28 comes into a registration with the runner, an opened state of the resin channel is obtained.

It is possible to use a molding unit A2 in place of the molding unit A1, as shown in FIGS. 9A to 9D. That is, the molding unit A2 comprises an upper mold 20A, a lower mold 10A having a first cylinder 11A, and a mold cavity 2A which is formed in a configuration of a molded article between the upper and lower molds. The upper mold 20A has a second cylinder 22A having a larger diameter than the first cylinder 11A of the lower mold 10A. The upper mold 20A is disposed on the lower mold such that an inside of the second cylinder 22A is joined with that of the first cylinder 11A. A second plunger 35A is slidably supported along an inner wall of the second cylinder 22A. The second plunger 35A exhibits the functions similar to the gate pin 22 of the molding unit A1. Pressures can be applied to a first plunger 30A and the second plunger 35A by using pressure devices (not shown).

An upper runner 21A extending to the inside of the second cylinder 22A is formed in a bottom surface of the upper mold 20A. A lower runner 12A is formed in a top surface of the lower mold 10A and adjacent to the first cylinder 11A. When the upper mold 20A is clamped to the lower mold 10A, the mold cavity 2A is connected with the inside of the second cylinder 22A through the lower runner 12A and the upper runner 21A to define a resin channel. As shown in FIG. 9B, when the second plunger 35A is pressed against the top surface of the lower mold 10A, it intercepts between the upper runner 21A and the inside of the first cylinder 11A to obtain a closed state of the resin channel. As shown in FIG. 9C, when the second plunger 35A is spaced away from the lower mold 10A, the upper runner 21A is joined with the inside of the first cylinder 11A through the inside of the second

cylinder 22A, so that an opened state of the resin channel is obtained. In FIG. 9A, the resin channel extending to the mold cavity 2A is drawn at only one side of the first cylinder 11A. However, it is possible to form a plurality of similar resin channels around the first cylinder 11A.

5 Prior to a transfer molding step with the use of the molding unit A2, a lead member such as a lead frame mounting thereon electronic components is set in the mold cavity 2A. In addition, a required amount of a powder-like resin material 1A such as a thermosetting resin is supplied into the first cylinders 11A of the lower mold 10A.

10 Subsequently, as shown in FIG. 9A, the upper mold 20A is clamped to the lower mold 10A. In this time, since the second plunger 35A is pressed against the top surface of the lower mold 10A, the resin channel is kept in the closed state. The upper and lower molds (20A, 10A) are heated by heaters to indirectly heat the resin material charged

15 into the first cylinder 11A. As shown in FIG. 9B, a second pressure greater than a first pressure applied to the first plunger 30A is loaded to the second plunger 35A toward the lower mold 10A by the pressure device. Therefore, the second plunger 35A does not retract even when the resin material is pressed by an upper movement of the first cylinder

20 11A. During this heating and pressing step of the resin material 1A, an air in the first cylinder 11A including an air left in the powder-like resin material is exhausted through a clearance between the first plunger 30A and the first cylinder.

Immediately after the resin material 1A is heated and pressed to

25 obtain a substantially melted state thereof, while the closed state of the resin channel being kept, the second pressure applied to the second

plunger 35A by the pressure device is released. The melted resin material is pressed by the first plunger 30A, so that the second plunger 35A is pushed up by the pressurized resin material 1A to obtain the opened state of the resin channel. The first plunger 30A and the first cylinder 11A are produced to tightly restricted dimensional tolerances such that the air in the first cylinder can be exhausted to the outside through a clearance between the first plunger and the first cylinder, but the melted resin material can not sink into the clearance in a short time period. In this molding unit A2, a regulation force is applied to the second plunger 35A by a pressure-regulating member such as a spring (not shown) such that an internal pressure of the melted resin material is maintained constant when the first plunger 30A is moved upwardly by a predetermined force after the second pressure is released from the second plunger. This is useful to inject the melted resin material at a constant pressure into the mold cavity 2A. In addition, when the upward movement of the second plunger 35A is controlled to adjust the extent of opening the upper runner 21A, it is possible to adequately determine a supply rate of the melted resin material into the mold cavity 2A. The melted resin material 1A pressurized by the first plunger 30A flows into the mold cavity 2A through the upper runner 21A and the lower runner 12A.

Next, as shown in FIG. 9D, the first plunger 30A is moved upwardly to a position where a top of the first plunger slightly projects into the second cylinder 22A, and fixed at the position. A pressure is applied to the second plunger 35A to pressurize the melted resin material left in the second cylinder 22A and inject it into the mold

cavity 2A. As result, the injection of the resin material 1A into the mold cavity is finished. Moving the second plunger 35A downwardly at the final stage of the injection is useful to stably supply the resin material into the mold cavity 2A at a constant injection speed. In addition, the air left in the powder-like resin material is removed before the resin channel is opened, therefore, it is possible to produce a good molded article with no void by the resin material injected into the mold cavity 2A. After the injection of the resin material into the mold cavity is finished, the molded article can be removed from the mold cavity according to a substantially same manner as the case of the molding unit A1.

Referring to a diagram of the FIG. 10, the transfer molding step with the use of the molding unit A2 is explained more concretely. The resin material 1A is charged into the first cylinder 11A, and then the second plunger 35A is moved downwardly to close the resin channel (S1 zone). After a bottom surface of the second plunger 35A contacts the top surface of the lower mold 10A, a pressure, e.g., about 500 kg/cm², is applied to the second plunger 35A to maintain the position of the second plunger during the heating and pressing step of the resin material (S2 zone). On the other hand, the resin material 1A is heated and pressed between the first and second plungers (30A, 35A) to exhaust the air left in the powder-like resin material to the outside (P1 zone). In the P1 zone, the resin material is gradually approaching its melted state. The lower mold 10A and the upper mold 20A are preheated at a required temperature. When a thermosetting resin is used as the resin material, both of the upper and lower molds (20A,

10A) are preferably heated at a temperature of 165°C to 185°C. After the pressure applied to the first plunger 30A reaches a predetermined pressure value, the pressurized resin material is kept for a time period, e.g., 0.5 to 2 seconds (P2 zone). Since the exhaustion of the air left in the first cylinder 11A to the outside continues during the time period, 5 the first plunger 30A slowly moves upwardly, as shown by the P2 zone of FIG. 10. As the predetermined pressure value, it is preferred that an internal pressure of the resin material in the first cylinder 11A is in a range of 100 to 300 kgf/cm². In the P2 zone, the resin material is in a substantially melted state. Immediately after the elapse of this time 10 period, the pressure applied to the second plunger 35A is removed, and the first plunger 30A is moved upwardly at a constant speed to pressurize the melted resin material (P3 zone). The melted resin material pressurized by the first plunger 30A pushes up the second 15 plunger 35A to make the opened state of the resin channel (S3 zone). The melted resin material is injected into the mold cavity 2A through the resin channel by a further upward movement of the first plunger 30A. When the first plunger reaches a position where the top of the first plunger slightly projects into the second cylinder 22A, e.g., a 20 position higher than a parting line by about 1 mm, the first plunger 30A is stopped and fixed to the position (P4 zone). The melted resin material left in the second cylinder 22A is pressurized by a downward movement of the second plunger 35A (S4 zone), and injected into the mold cavity 2A, so that the injection of the resin material 1A into the 25 mold cavity is finished.

The motions of the first and second plungers are stopped when the

mold cavity **2A** is filled with the melted resin material. Therefore, when a large amount of the resin material **1A** is charged into the first cylinder **11A**, the upward movement of the first plunger **30A** may be stopped at a position lower than the parting line within the **P3** zone. A
5 time period from the opening of the resin channel to the end of injection of the melted resin material may be in a range of 3 to 15 seconds depending on scale of the molded article. When the thermosetting resin is used as the resin material, a curing time of the resin material may be within a range about 30 to 90 seconds. Since a
10 curing reaction of the resin material starts when the resin material reaches the melted state, it is preferred to use an electric-type pressure device capable of controlling the motions of the first and second plungers with quick-response. In addition, when using the electric-type pressure device, it is possible to perform the transfer molding step
15 under a clean environment, as compared with the case of using an hydraulic pressure device.

In the molding unit **A2**, the second cylinder **22A** having a diameter larger than the first cylinder **11A** is used. However, as shown in FIGS. 11A to 11D, it is possible to use a molding unit **A3** having a
20 second cylinder **22B** having a diameter smaller than a first cylinder **11B**. That is, as shown in FIG. 11A, both of the second cylinder **22B** and a second plunger **35B** are moved downwardly such that an end surface of the second cylinder **22B** is pressed against a top surface of a lower mold **10B** to close upper runners **21B** of an upper mold **20B**. In this
25 closed state of a resin channel, a first plunger **30B** is moved upwardly to pressurize a powder-like resin material **1B**, while the resin material

being heated, as shown in FIG. 11B. At this time, since the second plunger **35A** is locked, it is not moved upwardly by the resin material **1B** pressurized by the first plunger **30B**. During this heating and pressing step of the resin material, an air in the first cylinder **11B** including an air left in the powder-like resin material is exhausted to the outside through a clearance between the first plunger **30B** and the first cylinder.

Immediately after the resin material **1B** is heated and pressed to obtain a substantially melted state thereof, while the closed state of the resin channel being kept, the second cylinder **22B** is moved upwardly to open the resin channel, and the locking of the second plunger **35B** is released to obtain a retractable state of the second plunger, as shown in FIG. 11C. At the same time, the first plunger **30B** is moved upwardly to push out the melted resin material into mold cavities **2B** through the upper runners **21B** and lower runners **12B**. When the first plunger **30B** reaches a required position, as shown in FIG. 11D, the motion of the first plunger is stopped and fixed to the position. Then a pressure is applied to the second plunger **35B** to push out the melted resin material left in the second cylinder **22B** into the mold cavities **2B** through the upper runners **21B**. As a result, the transfer molding step of the resin material **1B** into the mold cavities **2B** is finished. In FIG. 11A, numeral **40B** designates an ejector used to remove the molded article from the mold cavity **2B**.

For accurately measuring the powder-like resin material (**1**, **1A**, **1B**) and efficiently supplying the measured resin material to the molding unit (**A1**, **A2**, **A3**), as shown in FIG. 12, the unit **B** comprises a

hopper **101** used as a cartridge vessel for storing therein the powder-like resin material, a supporting section **102** for detachably supporting the hopper, a shutter **103**, a measuring section **104** for measuring a required amount of the resin material supplied from the hopper, and a supplying section **105** of the measured resin material. As shown in FIGS. 13A and 13B, the measuring section **104** comprises a case **110** having a circular cave **111**, a columnar rotor **120** having a peripheral surface **121** to be fitted to an inner surface of the circular cave and a measuring hole **122** formed in the peripheral surface, a measuring plunger **123** slidable along an inner wall of the measuring hole, and a plunger-position adjusting unit (not shown) for controlling a position of the measuring plunger in the measuring hole. The case **110** has a first through hole **112** extending between the circular cave **111** and a top surface of the case, and a second through hole **113** extending between the circular cave and a bottom surface of the case. The resin material (**1**, **1A**, **1B**) in the hopper **101** is supplied to the first through hole **112**. The columnar rotor **120** is rotatably supported about its axis between a first position where the first through hole **112** comes into a registration with the measuring hole **122**, as shown in FIG. 13A, and a second position where the second through hole **113** comes into a registration with the measuring hole, as shown in FIG. 13B. In FIG. 12, numeral **130** designates a rotary actuator for rotating the columnar rotor **120**. The adjusting unit adjusts the position of the measuring plunger **123** such that a measuring space surrounded with the inner surface of the circular cave **111**, the inner wall of the measuring hole **122** and the measuring plunger **123**, is substantially equal to a volume of the

required amount of the resin material. The resin material supplied into the measuring hole **122** through the first through hole **112** at the first position is transferred to the supplying section **105** through the second through hole **113** by the rotation of the columnar rotor **120** to the
5 second position.

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What is claimed is:

1. A resin molding apparatus for forming a molded article from a powder-like resin material comprising:
 - 5 an upper mold;
 - a lower mold having a cylinder;
 - heating means for heating said upper mold and said lower mold;
 - a plunger slidable along an inner wall of said cylinder, said resin material being charged into a space surrounded with said inner wall of said cylinder, said
 - 10 plunger, and said upper mold disposed at the opposite side of said plunger;
 - a mold cavity formed in a configuration of said molded article between said upper mold and said lower mold;
 - a runner connecting between said mold cavity and said space into which said resin material is charged; and
 - 15 gate means movable between a close position of said runner, where said resin material charged into said space is pressed by a movement of said plunger while being indirectly heated by said heating means, and an open position of said runner, where said resin material in a substantially melted state is pressed and supplied to said mold cavity by a further movement of said plunger, wherein said upper mold comprises: - 20 a second cylinder having a larger diameter than said cylinder of said

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lower mold, said upper mold disposed on said lower mold such that an inside of said second cylinder is joined with that of said cylinder;

a second plunger acting as said gate means which is slidable along an inner wall of said second cylinder, said second plunger making the close position of said runner when being pressed against said lower mold;

pressure loading means for applying a load to said second plunger toward said lower mold to press said resin material between said plunger and said second plunger while keeping the close position of said runner; and

pressure release means for removing said load applied to said second plunger, said second plunger making the open position of said runner when being spaced away from said lower mold.

2. A resin molding apparatus for forming a molded article from a powder-like resin material comprising:

an upper mold;

a lower mold having a cylinder;

heating means for heating said upper mold and said lower mold;

a plunger slidable along an inner wall of said cylinder, said resin material being charged into a space surrounded with said inner wall of said cylinder, said plunger, and said upper mold disposed at the opposite side of said plunger;

a mold cavity formed in a configuration of said molded article between said upper mold and said lower mold;

a runner connecting between said mold cavity and said space into which said resin material is charged; and

gate means movable between a close position of said runner, where said resin material charged into said space is pressed by a movement of said plunger while being indirectly heated by said heating means, and an open position of said runner, where said resin material in a substantially melted state is pressed and supplied to said mold cavity by a further movement of said plunger,

wherein said gate means is formed with a slide block which is slidably supported in a direction of crossing said runner, said slide block having a through hole extending in a lengthwise direction of said runner, and wherein the open position of said runner is obtained when said slide block is moved in said direction of crossing said runner such that said through hole comes into a registration with said runner.

3. The molding apparatus as set forth in claim 1, 2 or 5, wherein said gate means is formed with a pin projectable into said runner.

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4. The molding apparatus as set forth in claim 1 or 2 comprising a cartridge vessel for storing therein said resin material, support means for detachably supporting said cartridge vessel, measuring means for measuring a required amount of said resin material supplied from said cartridge vessel, and supply means for
5 supplying the required amount of said resin into said cylinder.

5. A resin molding apparatus for forming a molded article from a powder-like resin material comprising:

an upper mold;

10 a lower mold having a cylinder;

heating means for heating said upper mold and said lower mold;

a plunger slidable along an inner wall of said cylinder, said resin material being charged into a space surrounded with said inner wall of said cylinder, said plunger, and said upper mold disposed at the opposite side of said plunger;

15 a mold cavity formed in a configuration of said molded article between said upper mold and said lower mold;

a runner connecting between said mold cavity and said space into which said resin material is charged; and

gate means movable between a close position of said runner, where said resin
20 material charged into said space is pressed by a movement of said plunger while being indirectly heated by said heating means, and an open position of said runner, where said resin material in a substantially melted state is pressed and supplied to said mold cavity by a further movement of said plunger,

wherein said measuring means comprises:

25 a case having a circular cave, a first through hole extending between said circular cave and a top surface of said case, and a second through hole extending between said circular cave and a bottom surface of said case, said resin material of said cartridge vessel being supplied to said first through hole;

30 a columnar rotor having a peripheral surface to be fitted to an inner surface of said circular cave, and a measuring hole formed in said peripheral surface, said columnar rotor being rotatably supported about its axis between a first position where said first through hole comes into a registration with said measuring hole, and a second position where said second through hole comes into a registration with said measuring hole;

35 a third plunger slidable along an inner wall of said measuring hole;

means for adjusting a position of said third plunger such that a measuring space surrounded with said inner surface of said circular cave, said inner wall of said measuring hole and said third plunger is

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substantially a same as a volume of the required amount of said resin material; and
wherein said resin material supplied into said measuring hole through said first
through hole at said first position of said columnar rotor is transferred to said supply
means through said second through hole by a rotation of said columnar rotor to said
5 second position.

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LIST OF REFERENCE NUMERALS

1	powder-like resin material	123	measuring plunger
2	mold cavity	130	rotary actuator
8	frame		
10	lower mold	1A	powder-like resin material
11	cylinder	2A	mold cavity
12	runner	10A	lower mold
13	space	11A	first cylinder
15	lower attachment board	12A	lower runner
16	hole	20A	upper mold
17	lower base	21A	upper runner
20	upper mold	22A	second cylinder
21	concave	30A	first plunger
22	gate pin	35A	second plunger
23	upper attachment board		
25	upper base	1B	powder-like resin material
26	hole	2B	mold cavity
27	slide block	10B	lower mold
28	through hole	11B	first cylinder
30	plunger	12B	lower runner
31	columnar rod	20B	upper mold
40	ejector pin	21B	upper runner
50	spring	22B	second cylinder
60	magazine rack	30B	first plunger
61	supply pusher	35B	second plunger
62	table	40B	ejector
70	pick-up table		
71	second pusher	1D	powder-like resin material
80	magazine rack	2D	mold cavity
101	hopper	10D	lower mold
102	supporting section	11D	lower cylinder
103	shutter	12D	runner
104	measuring section	13D	inner space
105	supplying section	20D	upper mold
110	case	21D	concave
111	circular cave	30D	plunger
112	first through hole		
113	second through hole		
120	columnar rotor		
121	peripheral surface		
122	measuring hole		